3.3V ZERO DELAY CLOCK BUFFER

IDT2309B

FEATURES:

- Phase-Lock Loop Clock Distribution
- 10MHz to 133MHz operating frequency
- Distributes one clock input to one bank of five and one bank of four outputs
- Separate output enable for each output bank
- Output Skew < 250ps
- Low jitter <175 ps cycle-to-cycle
- 50ps typical cycle-to-cycle jitter (15pF, 66MHz)
- IDT2309B-1 for Standard Drive
- IDT2309B-1H for High Drive
- No external RC network required
- Operates at 3.3V V_{DD}
- Available in SOIC and TSSOP packages

NOTE: EOL for non-green parts to occur on 5/13/10 per PDN U-09-01

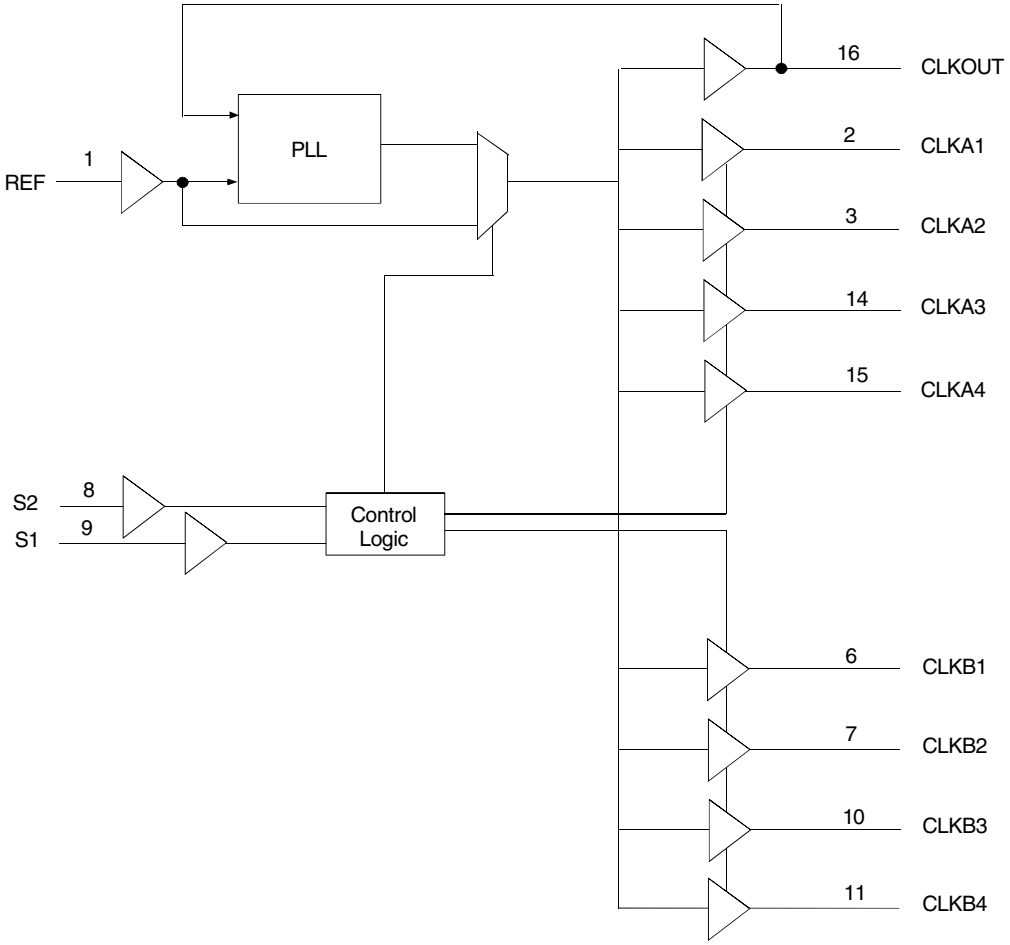
DESCRIPTION:

The IDT2309B is a high-speed phase-lock loop (PLL) clock buffer, designed to address high-speed clock distribution applications. The zero delay is achieved by aligning the phase between the incoming clock and the output clock, operable within the range of 10 to 133MHz.

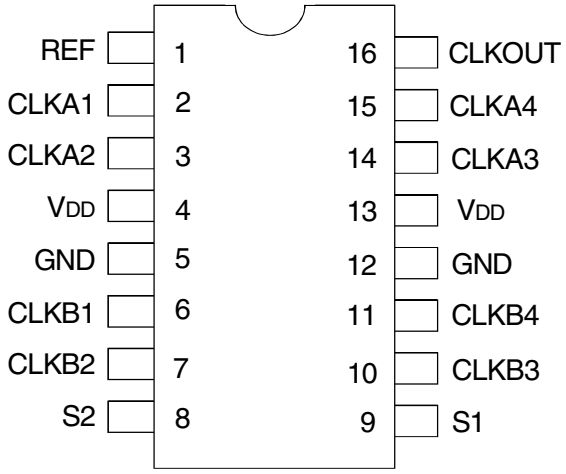
The IDT2309B is a 16-pin version of the IDT2305B. The IDT2309B accepts one reference input, and drives two banks of four low skew clocks. The -1H version of this device operates at up to 133MHz frequency and has higher drive than the -1 device. All parts have on-chip PLLs which lock to an input clock on the REF pin. The PLL feedback is on-chip and is obtained from the CLKOUT pad. In the absence of an input clock, the IDT2309B enters power down, and the outputs are tri-stated. In this mode, the device will draw less than 25µA.

The IDT2309B is characterized for both Industrial and Commercial operation.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION



SOIC/ TSSOP
TOP VIEW

APPLICATIONS:

- SDRAM
- Telecom
- Datacom
- PC Motherboards/Workstations
- Critical Path Delay Designs

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Rating	Max.	Unit
V_{DD}	Supply Voltage Range	–0.5 to +4.6	V
V_I(2)	Input Voltage Range (REF)	–0.5 to +5.5	V
V_I	Input Voltage Range (except REF)	–0.5 to V_{DD}+0.5	V
I_{IK} (V_I < 0)	Input Clamp Current	–50	mA
I_O (V_O = 0 to V_{DD})	Continuous Output Current	±50	mA
V_{DD} or GND	Continuous Current	±100	mA
T_A = 55°C (in still air)(3)	Maximum Power Dissipation	0.7	W
T_{STG}	Storage Temperature Range	–65 to +150	°C
Operating Temperature	Commercial Temperature Range	0 to +70	°C
Operating Temperature	Industrial Temperature Range	-40 to +85	°C

NOTES:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

PIN DESCRIPTION

Pin Name	Pin Number	Type	Functional Description
REF(1)	1	IN	Input reference clock, 5 Volt tolerant input
CLKA1(2)	2	Out	Output clock for bank A
CLKA2(2)	3	Out	Output clock for bank A
V_{DD}	4, 13	PWR	3.3V Supply
GND	5, 12	GND	Ground
CLKB1(2)	6	Out	Output clock for bank B
CLKB2(2)	7	Out	Output clock for bank B
S2(3)	8	IN	Select input Bit 2
S1(3)	9	IN	Select input Bit 1
CLKB3(2)	10	Out	Output clock for bank B
CLKB4(2)	11	Out	Output clock for bank B
CLKA3(2)	14	Out	Output clock for bank A
CLKA4(2)	15	Out	Output clock for bank A
CLKOUT(2)	16	Out	Output clock, internal feedback on this pin

NOTES:
1. Weak pull down.
2. Weak pull down on all outputs.
3. Weak pull ups on these inputs.

FUNCTION TABLE(1)

S2	S1	CLKA	CLKB	CLKOUT(2)	Output Source	PLL Shut Down
L	L	Tri-State	Tri-State	Driven	PLL	N
L	H	Driven	Tri-State	Driven	PLL	N
H	L	Driven	Driven	Driven	REF	Y
H	H	Driven	Driven	Driven	PLL	N

NOTES:
1. H = HIGH Voltage Level.
   L = LOW Voltage Level
2. This output is driven and has an internal feedback for the PLL. The load on this ouput can be adjusted to change the skew between the REF and the output.

DC ELECTRICAL CHARACTERISTICS - COMMERCIAL

Symbol	Parameter	Conditions		Min.	Max.	Unit
V_{IL}	Input LOW Voltage Level			—	0.8	V
V_{IH}	Input HIGH Voltage Level			2	—	V
I_{IL}	Input LOW Current	V_{IN} = 0V		—	50	µA
I_{IH}	Input HIGH Current	V_{IN} = V_{DD}		—	100	µA
V_{OL}	Output LOW Voltage	Standard Drive	I_{OL} = 8mA	—	0.4	V
		High Drive	I_{OL} = 12mA (-1H)			
V_{OH}	Output HIGH Voltage	Standard Drive	I_{OH} = -8mA	2.4	—	V
		High Drive	I_{OH} = -12mA (-1H)			
I_{DD_PD}	Power Down Current	REF = 0MHz (S2 = S1 = H)		—	12	µA
I_{DD}	Supply Current	Unloaded Outputs at 66.66MHz, SEL inputs at V_{DD} or GND		—	32	mA

OPERATING CONDITIONS - COMMERCIAL

Symbol	Parameter	Min.	Max.	Unit
V_{DD}	Supply Voltage	3	3.6	V
T_A	Operating Temperature (Ambient Temperature)	0	70	°C
C_L	Load Capacitance < 100MHz	—	30	pF
	Load Capacitance 100MHz - 133MHz	—	10	
C_{IN}	Input Capacitance	—	7	pF

SWITCHING CHARACTERISTICS (2309B-1) - COMMERCIAL(1,2)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_1	Output Frequency	10pF Load	10	—	133	MHz
		30pF Load	10	—	100	
	Duty Cycle = $t_2 \div t_1$	Measured at 1.4V, F_{OUT} = 66.66MHz	40	50	60	%
t_3	Rise Time	Measured between 0.8V and 2V	—	—	2.5	ns
t_4	Fall Time	Measured between 0.8V and 2V	—	—	2.5	ns
t_5	Output to Output Skew	All outputs equally loaded	—	—	250	ps
t_{6A}	Delay, REF Rising Edge to CLKOUT Rising Edge(2)	Measured at $V_{DD}/2$	—	0	±350	ps
t_{6B}	Delay, REF Rising Edge to CLKOUT Rising Edge(2)	Measured at $V_{DD}/2$ in PLL bypass mode (IDT2309B only)	1	5	8.7	ns
t_7	Device-to-Device Skew	Measured at $V_{DD}/2$ on the CLKOUT pins of devices	—	0	700	ps
t_J	Cycle-to-Cycle Jitter	Measured at 66.66MHz, loaded outputs	—	50	175	ps
t_{LOCK}	PLL Lock Time	Stable power supply, valid clock presented on REF pin	—	—	1	ms

NOTES:
1. REF Input has a threshold voltage of $V_{DD}/2$.
2. All parameters specified with loaded outputs.

SWITCHING CHARACTERISTICS (2309B-1H) - COMMERCIAL[1,2]

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_1	Output Frequency	10pF Load	10	—	133	MHz
		30pF Load	10	—	100	
	Duty Cycle = $t_2 \div t_1$	Measured at 1.4V, F_{OUT} = 66.66MHz	40	50	60	%
	Duty Cycle = $t_2 \div t_1$	Measured at 1.4V, F_{OUT} <50MHz	45	50	55	%
t_3	Rise Time	Measured between 0.8V and 2V	—	—	1.5	ns
t_4	Fall Time	Measured between 0.8V and 2V	—	—	1.5	ns
t_5	Output to Output Skew	All outputs equally loaded	—	—	250	ps
t_{6A}	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at $V_{DD}/2$	—	0	±350	ps
t_{6B}	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at $V_{DD}/2$ in PLL bypass mode (IDT2309 only)	1	5	8.7	ns
t_7	Device-to-Device Skew	Measured at $V_{DD}/2$ on the CLKOUT pins of devices	—	0	700	ps
t_8	Output Slew Rate	Measured between 0.8V and 2V using Test Circuit 2	1	—	—	V/ns
t_J	Cycle-to-Cycle Jitter	Measured at 66.66MHz, loaded outputs	—	—	175	ps
t_{LOCK}	PLL Lock Time	Stable power supply, valid clock presented on REF pin	—	—	1	ms

NOTES:
1. REF Input has a threshold voltage of $V_{DD}/2$.
2. All parameters specified with loaded outputs.

DC ELECTRICAL CHARACTERISTICS - INDUSTRIAL

Symbol	Parameter	Conditions		Min.	Max.	Unit
V_{IL}	Input LOW Voltage Level			—	0.8	V
V_{IH}	Input HIGH Voltage Level			2	—	V
I_{IL}	Input LOW Current	V_{IN} = 0V		—	50	µA
I_{IH}	Input HIGH Current	V_{IN} = V_{DD}		—	100	µA
V_{OL}	Output LOW Voltage	Standard Drive	I_{OL} = 8mA	—	0.4	V
		High Drive	I_{OL} = 12mA (-1H)			
V_{OH}	Output HIGH Voltage	Standard Drive	I_{OH} = -8mA	2.4	—	V
		High Drive	I_{OH} = -12mA (-1H)			
I_{DD_PD}	Power Down Current	REF = 0MHz (S2 = S1 = H)		—	25	µA
I_{DD}	Supply Current	Unloaded Outputs at 66.66MHz, SEL inputs at V_{DD} or GND		—	35	mA

OPERATING CONDITIONS - INDUSTRIAL

Symbol	Parameter	Min.	Max.	Unit
V_{DD}	Supply Voltage	3	3.6	V
T_A	Operating Temperature (Ambient Temperature)	-40	+85	°C
C_L	Load Capacitance < 100MHz	—	30	pF
	Load Capacitance 100MHz - 133MHz	—	10	
C_{IN}	Input Capacitance	—	7	pF

SWITCHING CHARACTERISTICS (2309B-1) - INDUSTRIAL (1,2)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_1	Output Frequency	10pF Load	10	—	133	MHz
		30pF Load	10	—	100	
	Duty Cycle = $t_2 \div t_1$	Measured at 1.4V, F_{OUT} = 66.66MHz	40	50	60	%
t_3	Rise Time	Measured between 0.8V and 2V	—	—	2.5	ns
t_4	Fall Time	Measured between 0.8V and 2V	—	—	2.5	ns
t_5	Output to Output Skew	All outputs equally loaded	—	—	250	ps
t_{6A}	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at $V_{DD}/2$	—	0	±350	ps
t_{6B}	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at $V_{DD}/2$ in PLL bypass mode (IDT2309B only)	1	5	8.7	ns
t_7	Device-to-Device Skew	Measured at $V_{DD}/2$ on the CLKOUT pins of devices	—	0	700	ps
t_J	Cycle-to-Cycle Jitter	Measured at 66.66MHz, loaded outputs	—	50	175	ps
t_{LOCK}	PLL Lock Time	Stable power supply, valid clock presented on REF pin	—	—	1	ms

NOTES:
1. REF Input has a threshold voltage of $V_{DD}/2$.
2. All parameters specified with loaded outputs.

SWITCHING CHARACTERISTICS (2309B-1H) - INDUSTRIAL (1,2)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_1	Output Frequency	10pF Load	10	—	133	MHz
		30pF Load	10	—	100	
	Duty Cycle = $t_2 \div t_1$	Measured at 1.4V, F_{OUT} = 66.66MHz	40	50	60	%
	Duty Cycle = $t_2 \div t_1$	Measured at 1.4V, F_{OUT} <50MHz	45	50	55	%
t_3	Rise Time	Measured between 0.8V and 2V	—	—	1.5	ns
t_4	Fall Time	Measured between 0.8V and 2V	—	—	1.5	ns
t_5	Output to Output Skew	All outputs equally loaded	—	—	250	ps
t_{6A}	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at $V_{DD}/2$	—	0	±350	ps
t_{6B}	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at $V_{DD}/2$ in PLL bypass mode (IDT2309B only)	1	5	8.7	ns
t_7	Device-to-Device Skew	Measured at $V_{DD}/2$ on the CLKOUT pins of devices	—	0	700	ps
t_8	Output Slew Rate	Measured between 0.8V and 2V using Test Circuit 2	1	—	—	V/ns
t_J	Cycle-to-Cycle Jitter	Measured at 66.66MHz, loaded outputs	—	—	175	ps
t_{LOCK}	PLL Lock Time	Stable power supply, valid clock presented on REF pin	—	—	1	ms

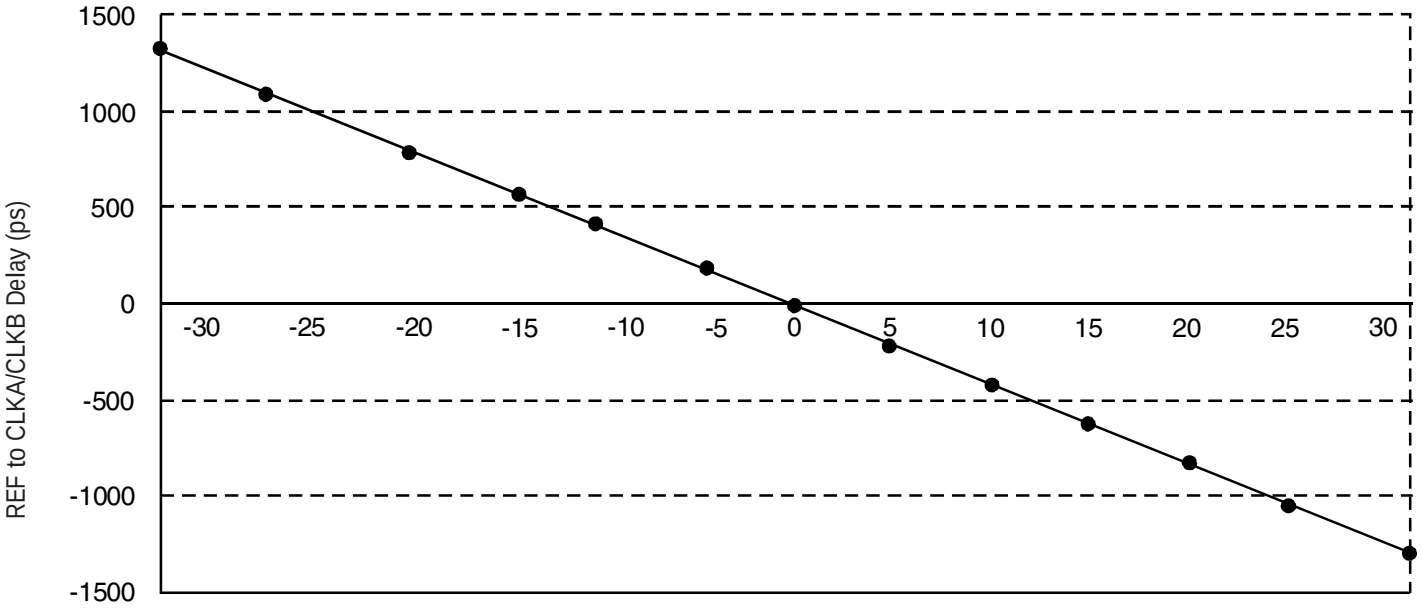
NOTES:
1. REF Input has a threshold voltage of $V_{DD}/2$.
2. All parameters specified with loaded outputs.

ZERO DELAY AND SKEW CONTROL

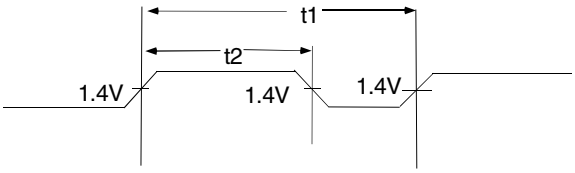
All outputs should be uniformly loaded in order to achieve Zero I/O Delay. Since the CLKOUT pin is the internal feedback for the PLL, its relative loading can affect and adjust the input/output delay. The Output Load Difference diagram illustrates the PLL's relative loading with respect to the other outputs that can adjust the Input-Output (I/O) Delay.

For designs utilizing zero I/O Delay, all outputs including CLKOUT must be equally loaded. Even if the output is not used, it must have a capacitive load equal to that on the other outputs in order to obtain true zero I/O Delay. If I/O Delay adjustments are needed, use the Output Load Difference diagram to calculate loading differences between the CLKOUT pin and other outputs. For zero output-to-output skew, all outputs must be loaded equally.

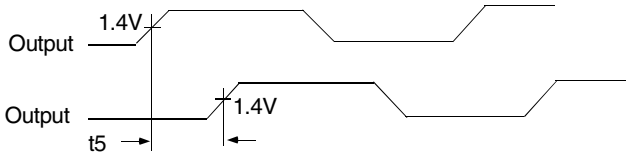
REF TO CLKA/CLKB RELAY vs. OUTPUT LOAD DIFFERENCE BETWEEN CLKOUT PIN AND CLKA/CLKB PINS



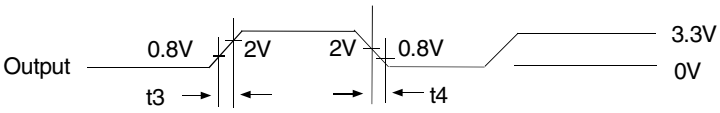
SWITCHING WAVEFORMS



Duty Cycle Timing

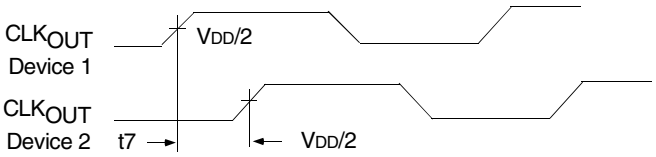


Output to Output Skew



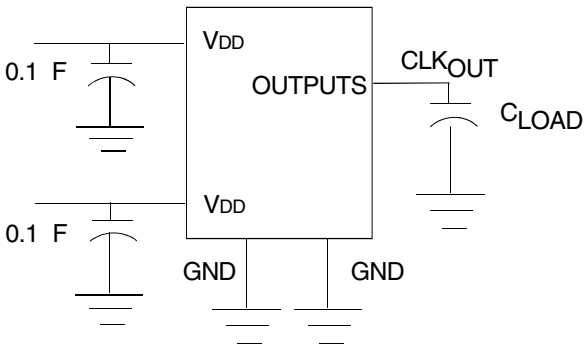
All Outputs Rise/Fall Time

Input to Output Propagation Delay

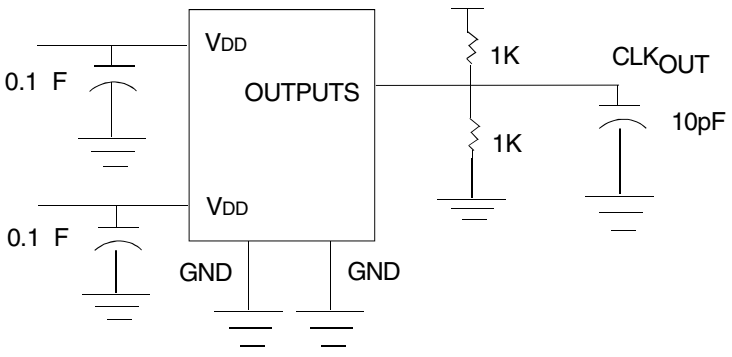


Device to Device Skew

TEST CIRCUITS

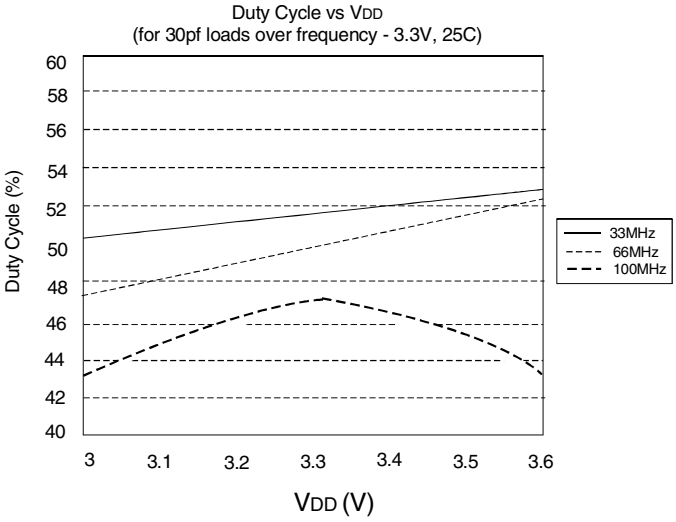


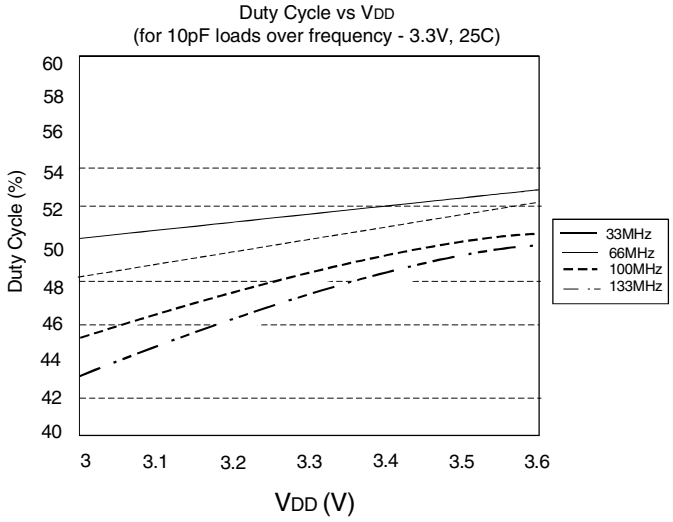
Test Circuit 1 (all Parameters Except t8)

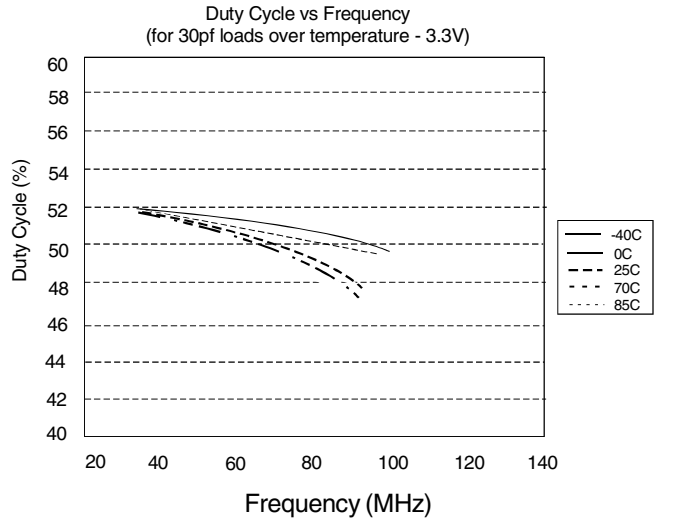


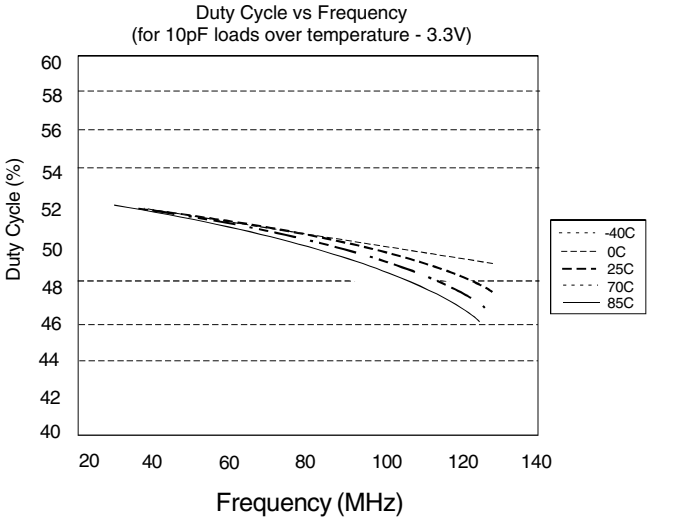
Test Circuit 2 (t8, Output Slew Rate On -1H Devices)

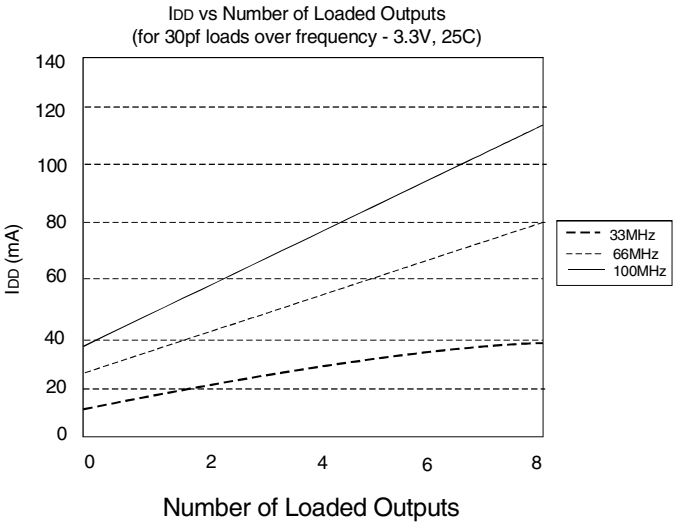
TYPICAL DUTY CYCLE(1) AND IDD TRENDS(2) FOR IDT2309B-1

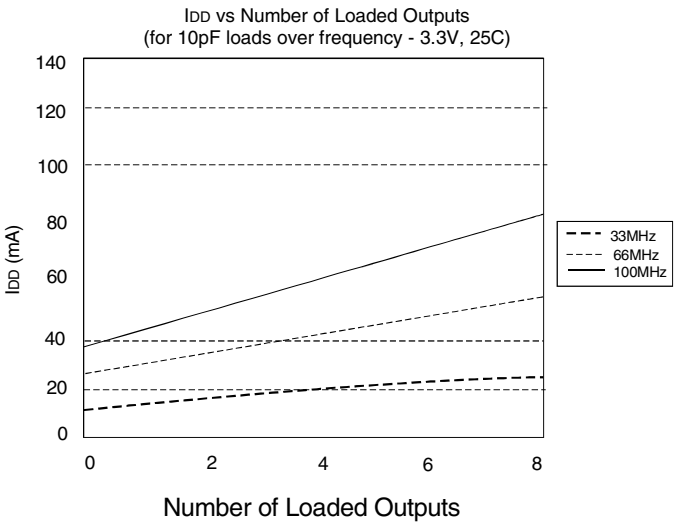






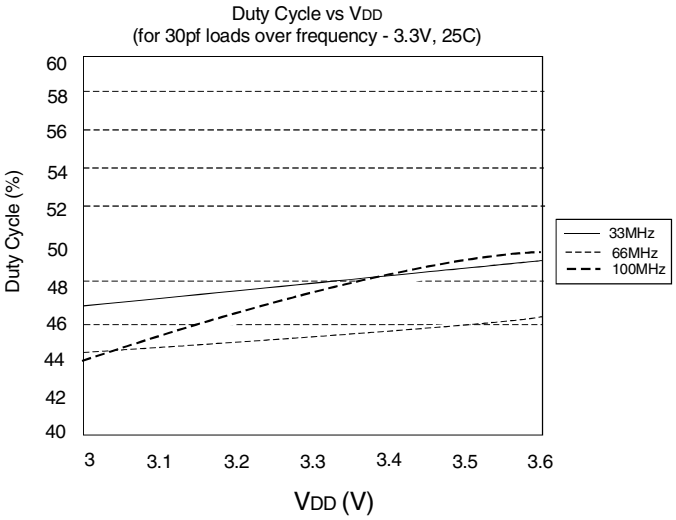


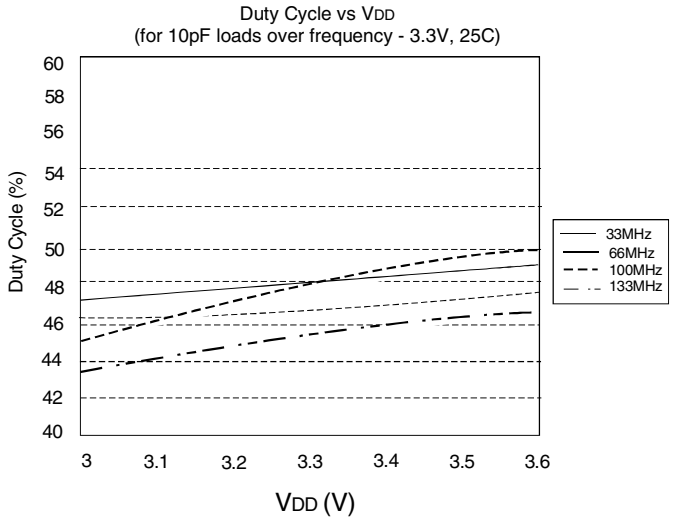


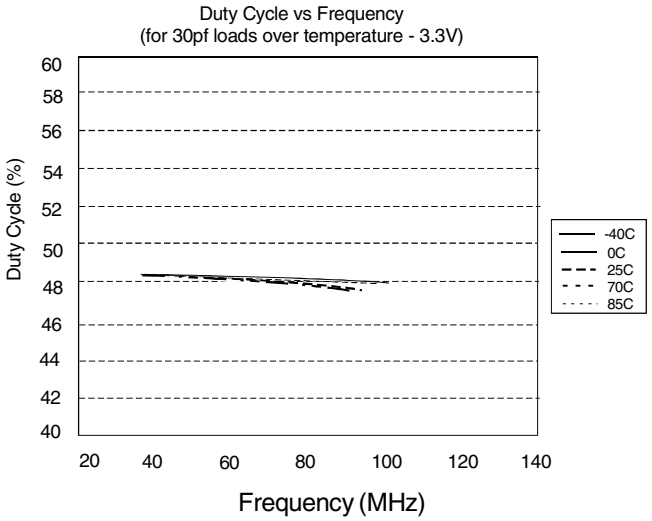


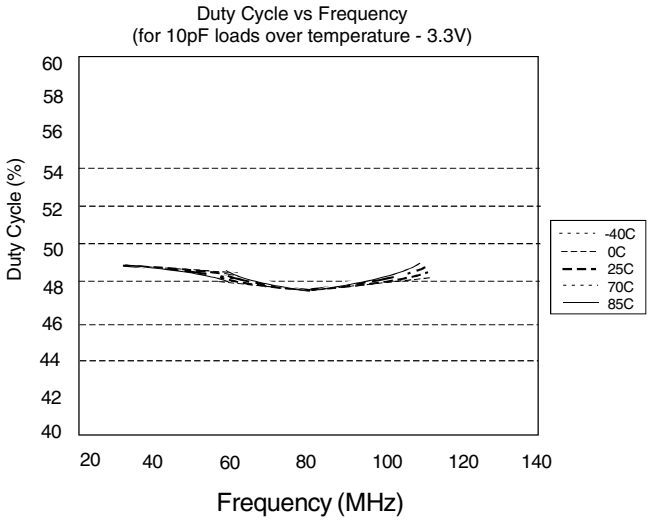
NOTES:
1. Duty Cycle is taken from typical chip measured at 1.4V.
2. IDD data is calculated from IDD = ICORE + nCVf, where ICORE is the unloaded current. (n = Number of outputs; C = Capacitance load per output (F); V = Supply Voltage (V); f = Frequency (Hz))

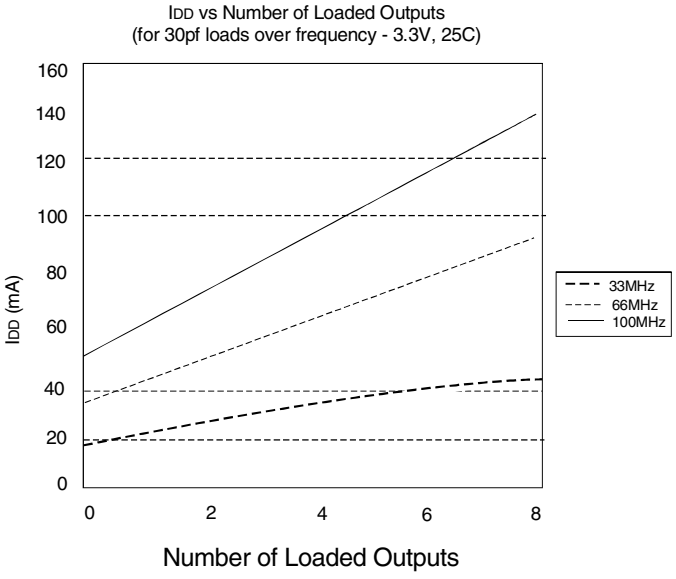
TYPICAL DUTY CYCLE(1) AND IDD TRENDS(2) FOR IDT2309B-1H

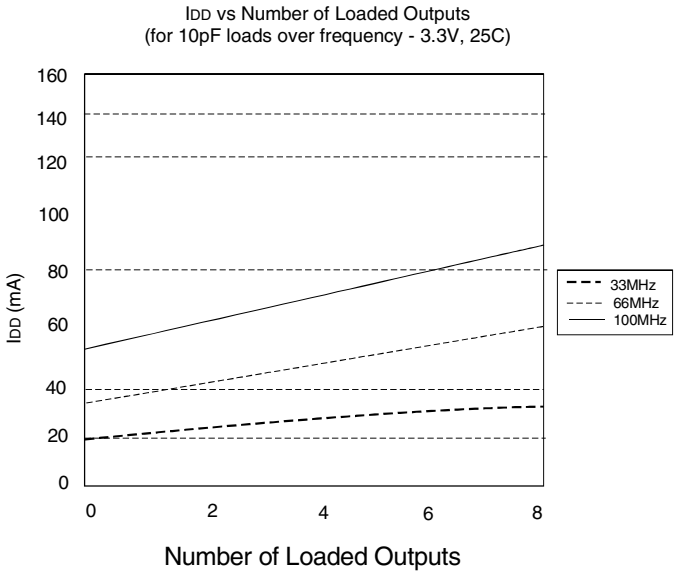






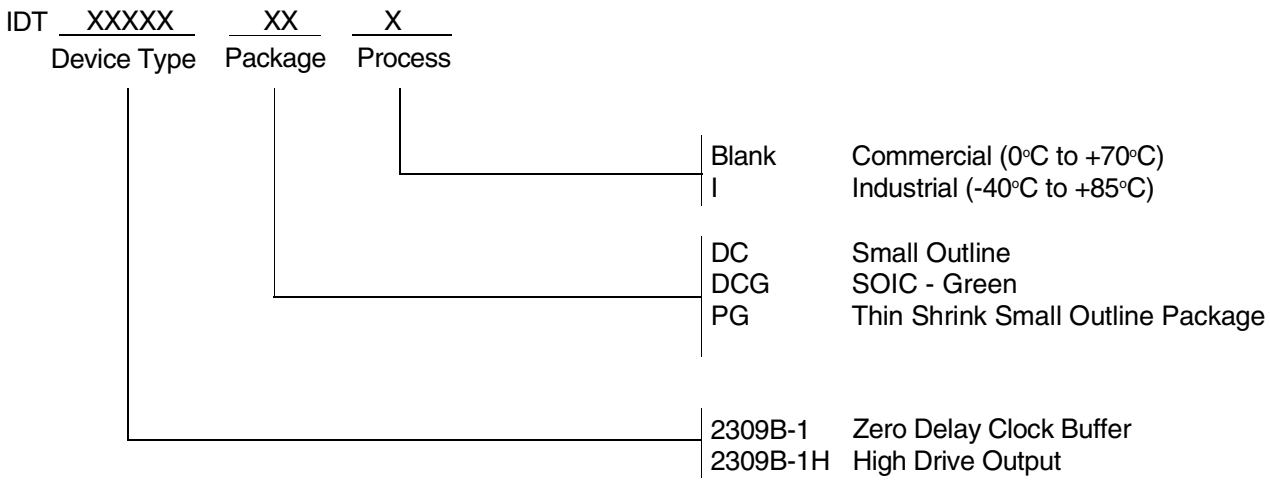






NOTES:
1. Duty Cycle is taken from typical chip measured at 1.4V.
2. IDD data is calculated from IDD = ICORE + nCVf, where ICORE is the unloaded current. (n = Number of outputs; C = Capacitance load per output (F); V = Supply Voltage (V); f = Frequency (Hz))

ORDERING INFORMATION



NOTE: EOL for non-green parts to occur on 5/13/10 per PDN U-09-01

Ordering Code	Package Type	Operating Range
IDT2309B-1DC*	16-Pin SOIC	Commercial
IDT2309B-1HDC*	16-Pin SOIC	Commercial
IDT2309B-1HDCG	16-Pin SOIC	Commercial
IDT2309B-1HDCGI	16-Pin SOIC	Industrial
IDT2309B-1HDCI*	16-Pin SOIC	Industrial
IDT2309B-1HPG	16-Pin TSSOP	Commercial

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800-345-7015 or 408-284-8200
fax: 408-284-2775
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clockhelp@idt.com